

EXPRESS MAIL NO. EV415842462US

Docket No. 85A 3503
Date: February 17, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith for filing is the patent application for inventor(s):

TATSUNARI MII

For: BUMP FORMATION METHOD AND WIRE BONDING METHOD

Also enclosed are:

- 6 sheets of drawings
- Certified copy of Japanese Patent Application No. 2003-038312 of February 17, 2003 on which Convention priority is claimed
- Declaration and Power of Attorney
- Information Disclosure Statement by Applicant
- An assignment of the invention to KABUSHIKI KAISHA SHINKAWA

Applicant claims Small Entity Status

CALCULATION OF FEES								
ITEM		TOTAL NO. OF CLAIMS		NO. OF CLAIMS OVER BASE	LG/SM \$ ENTITY FEE		\$ AMOUNT	\$ FEE
A	TOTAL CLAIMS FEE	4	-20	0	LG=\$18 SM=\$9	\$9	\$ 0	
B	INDEPENDENT CLAIMS FEE*	4	-3	1	LG=\$86 SM=\$43	\$43	\$ 43	
C	SUBTOTAL - ADDITIONAL CLAIMS FEE (ADD FINAL COLUMN IN LINES A + B)							\$ 43
D	MULTIPLE-DEPENDENT CLAIMS FEE							LARGE ENTITY FEE = \$290 SMALL ENTITY FEE = \$145 \$ 0
E	BASIC FEE							LARGE ENTITY FEE = \$770 SMALL ENTITY FEE = \$385 \$ 385
F	TOTAL FILING FEE (ADD TOTALS FOR LINES C, D, AND E)							\$ 428
G	ASSIGNMENT RECORDING FEE							\$ 40 \$ 40

*LIST INDEPENDENT CLAIMS 1-4

- The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Account No. 11-1445. A duplicate copy of this sheet is enclosed.
- A check in the amount of \$ 428 to cover the filing fee is enclosed.
- A check in the amount of \$ 40 to cover Assignment Recordation fee is enclosed.

Respectfully submitted,
KODA & ANDROLIA

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on February 17, 2004 by Inja Yi.

Dated: 2/17/04

By: 

85A 3503	SHINKAWA
Applicant(s):	TATSUNARI MI
For:	BUMP FORMATION METHOD AND WIRE BONDING METHOD